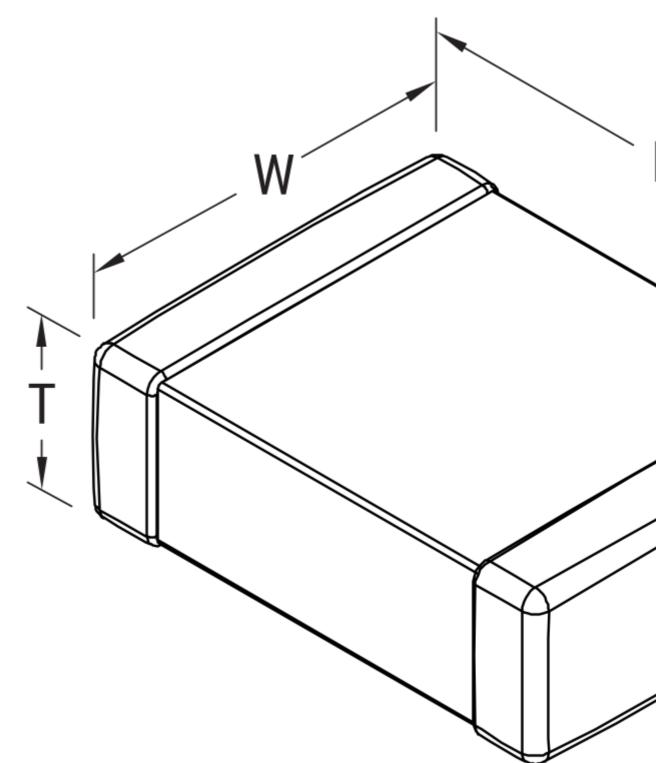
CBR02C299A3GAC

CBR-SMD RF C0G, Ceramic, 2.9 pF, +/-0.05 pF, 25 VDC, C0G, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0201



Click <u>here</u> for the 3D model. **Dimensions**

Chip Size 0201

- L 0.6mm +/-0.03mm
- W 0.3mm +/-0.03mm
- T 0.3mm +/-0.03mm

Dimensions

B 0.15mm	+/-0.05mm
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Pa	cka	ging		T&R, 180mm, Plastic Tape
_			-	

Packaging Quantity 15000

General Information

	C					
Series	CBR-SMD	RF C0G				
Style	SMD Chip					
Description	SMD, Fixe	d, RF, Ultra High Q, Low ESR, Class I				
Features	Ultra High	Ultra High Q, Low ESR, Class I				
RoHS	Yes					
Termination	Tin					
Marking	No					
AEC-Q200	No					
Component Weight 0.3 mg						
Notes	Solder Refl	ow Only.				
Shelf Life	78 Weeks					
MSL	1					
Specifications						
Capacitance		2.9 pF				
Capacitance Tolera	ance	+/-0.05 pF				
Voltage DC		25 VDC				
Dielectric Withstanding Voltage 62.5 VDC						
Temperature Rang	e	-55/+125°C				
Temperature Coeff	ficient	C0G				
Dissipation Factor		0.218%				
Aging Rate		0% Loss/Decade Hour				
Insulation Resistan	ice	10 GOhms				
Quality Factor		458				

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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